

General Description

The MAX2370 evaluation kit (EV kit) simplifies the testing and evaluation of the MAX2370 quadrature transmitter. The EV kit provides 50Ω SMA connectors for all RF inputs and outputs. A varactor-based tank circuit is provided for the on-chip IF voltage-controlled oscillator (VCO) and phase locked with an on-chip PLL. I/Q baseband inputs come with standard BNC connectors.

The EV kit allows evaluation of the MAX2370 I/Q modulator, IF VGA, RF upconverter, IF VCO, dual synthesizer, 3-wire programming interface, and power-management features.

SPI/QSPI are trademarks of Motorola, Inc. MICROWIRE is a trademark of National Semiconductor Corp.

DESIGNATION	QTY	DESCRIPTION
C1, C2, C16, C20, C39, C65, C66, C80	8	100pF ±5% ceramic capacitors (0402) Murata GRM1555C1H101J
C3, C11, C13, C14, C26, C27, C33, C38, C40, C41, C43, C48, C52, C56, C58, C59, C60, C64, C67, C68, C82–C85	0	Open
C4, C5, C42, C75, C79, C88, C91, C93, C95, C96, C97	11	0.1µF ±10% ceramic capacitors (0402) Murata GRM155R61C104K
C6	1	4.7pF ±0.1pF ceramic capacitor (0402) Murata GRM1555C1H4R7B
C7, C10, C18, C19, C21, C30, C31, C35, C63, C76, C78, C81	12	1000pF ±10% ceramic capacitors (0402) Murata GRM155R71H102K
C8, C9, C15, C17, C34, C55, C57	7	0.01µF ±10% ceramic capacitors (0402) Murata GRM155R71C103K
C12	1	1.2pF ±0.1pF ceramic capacitor (0402) Murata GRM1555C1H1R2B
C22, C23	2	33pF ±5% ceramic capacitors (0402) Murata GRM1555C1H330J

Component List

Features

- 50Ω SMA Connectors on All RF Ports
- BNC Connectors for Baseband Inputs
- Fully Assembled and Tested
- Low-Power Shutdown Mode
- ◆ SPI™/QSPI™/MICROWIRE™ Compatible
- PC Control Software (Available at www.maxim-ic.com)

Ordering Information

PART	TEMP RANGE	IC PACKAGE
MAX2370EVKIT	-40°C to +85°C	48 Thin QFN-EP*

*EP = Exposed paddle.

Quick Start

The MAX2370 EV kit is fully assembled and factory tested. Follow the instructions in the *Connections and Setup* section.

Test Equipment Required

This section lists the recommended test equipment to verify the operation of the MAX2370. It is intended as a guide only, and substitutions may be possible.

- One low-noise signal generator capable of generating a 19.2MHz signal at 600mVp-p for the PLL reference frequency
- One RF signal generator capable of generating signals in the 530MHz to 695MHz frequency range with a minimum output power of -15dBm for the RF local oscillator
- An RF spectrum analyzer with optional digital modulation personality (Rohde and Schwarz FSEA30 or equivalent)
- A power supply that can provide 250mA at +3.0V
- A power supply that can provide 50mA at +5V
- An additional voltage source adjustable from 0 to 2.5V for control of the VGA functions

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For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

DESIGNATION	QTY	DESCRIPTION
C24, C25	2	9pF ±0.1pF ceramic capacitors (0402) Murata GRM1555C1H9R0B
C28	1	0.033µF ±10% ceramic capacitor (0402) Murata GRM155R71A333K
C29	1	0.022µF ±10% ceramic capacitor (0402) Murata GRM155R71C223K
C32	1	1.0µF ±10% ceramic capacitor (0805) Murata GRM21BR71C105K
C36	1	3300pF ±10% ceramic capacitor (0402) Murata GRM155R71H332K
C37	1	0.047µF ±10% ceramic capacitor (0402) Murata GRM155R71A473K
C44, C45, C46	3	15pF ±5% ceramic capacitors (0402) Murata GRM1555C1H150J
C47, C50	2	9.1pF ±0.1pF ceramic capacitors (0402) Murata GRM1555C1H9R1B
C49	1	2.7pF ±0.1pF ceramic capacitor (0402) Murata GRM1555C1H2R7B
C51	1	1.5pF ±0.1pF ceramic capacitor (0402) Murata GRM1555C1H1R5B
C53, C54	2	10pF ±5% ceramic capacitors (0402) Murata GRM1555C1H100J

- I/Q arbitrary waveform generator or CDMA generator (Agilent E4433B or equivalent)
- PC (486DX33 or better) with Windows[®] 95/98/2000/ NT 4.0 or later operating system and an available parallel port
- INTF2300 interface board and cable (supplied with EV kit)

Connections and Setup

This section provides step-by-step instructions for getting the EV kit up and running for evaluation of the MAX2370 in 455MHz CDMA mode.

1) Verify shunts JU1 and JU6–JU10 are in place.

Windows is a registered trademark of Microsoft Corp.

Component List (continued)

DESIGNATION	QTY	DESCRIPTION	
C70, C71	2	22μF ±10% tantalum capacitors (B-case) AVX TAJB226K010	
C72, C73, C94	3	1.0μF ±10% ceramic capacitors (0603) Murata GRM188R61A105K	
C74, C77, C86	3	10μF ±20% tantalum capacitors (B-case) AVX TAJB106K010	
D1, D2, D4, D5	4	Varactor diodes Alpha Industries SMV1763-079	
D3	1	LED	
FL1	0	Open	
FL2	0	Open	
J1, J16, J20, J21, J24, J25, J27	7	SMA connectors—edge mount Johnson 142-0701-801	
J2, J6, J22	0	Open	
J3, J7	2	BNC connectors A/D Electronics 580-002-00	
JP1	1	2 x 10 header Sullins PTC36DAAN	
JU1–JU4, JU6, JU7–JU10	9	1 x 2 headers Sullins PTC36SAAN	
JU1, JU6–JU10	6	Shunts Sullins STC02SYAN	
JU11–JU16, LOCK TESTPOINT, RBIAS	8	Test points Keystone 5000	

- 2) Connect the INTF2300 interface cable from the INTF2300 interface board to the MAX2370 EV kit. Pin 1 of the interface cable corresponds to the red wire. Pin 1 of the connectors are designated in the silkscreen on the MAX2370 and INTF2300 boards.
- 3) Connect a +3V power supply to the headers labeled VBAT and VREG. The INTF2300 board derives its power from the MAX2370 EV kit.
- 4) Connect a +5V power supply to the header labeled +5V.
- 5) With its output disabled, connect the low-noise signal generator to the REF port. Set its frequency to 19.2MHz and its amplitude to -10dBm.
- 6) With its output disabled, connect the RF signal generator to the LOL port. Set its frequency to 575MHz and its amplitude to -10dBm.



DESIGNATION	QTY	DESCRIPTION
L1	1	47nH ±5% inductor (0603)
L2, L3	2	100nH ±5% inductors (0603)
L4, L6, L7, L11, L16	0	Open
L5, L19	2	220nH ±5% inductors (0603)
L9	1	56nH ±5% inductor (0603)
L10	1	11nH ±5% inductor (0603)
Q1, Q2	2	npn transistors Central Semiconductor CMPT8099
R1, R2, R7, R19, R24, R47, R52	7	47k Ω ±5% resistors (0402)
R3	1	51k Ω ±5% resistor (0402)
R4, R5, R29, R30	4	1k Ω ±5% resistors (0402)
R6, R10, R11, R12, R15, R17, R20, R26, R37, R44, R46, R49, R53, R55, R58–R61, R70, R73, R76–R84	0	Open
R8, R16, R28, R48, R50, R51	6	511 Ω ±1% resistors (0805)
R9, R18	2	$39.2\Omega \pm 1\%$ resistors (0805)
R13, R22	2	$680\Omega \pm 5\%$ resistors (0805)
R14, R21, R41, R42	4	$100\Omega \pm 1\%$ resistors (0402)

- 7) Enable the low-noise signal generator's output; then enable the RF signal generator's output.
- 8) Install and run Maxim's CDMA control software for the MAX2370 evaluation kit. This software is available on the web at www.maxim-ic.com/tools/evkit. On the IC selection form, select 2363-P3. Click on the Register View button (Note: The MAX2363 Register View screen is also used to program the MAX2370.)
- 9) With the MAX2363-P3 control screen active, set the registers according to Table 1. Set the reference frequency in the control screen to 19.2MHz.
- 10) Click on the Send Data button for each of the control registers located at the right of the screen. There are eight registers that need to be downloaded to the IC. The Lock indicator on the screen should be red, indicating that the IF PLL is locked.
- 11) Apply 2.5V to the VGC header (JU4).

DESIGNATION QTY DESCRIPTION R23, R45 2 $1k\Omega \pm 1\%$ resistors (0805) R25, R33, R34, 7 R38, R39, R57, $0\Omega \pm 5\%$ resistors (0402) R62 R27. R74 2 $10k\Omega \pm 5\%$ resistors (0402) R31, R32, R35, 5.1kΩ ±5% resistors (0402) 4 R36 R40 $12k\Omega \pm 5\%$ resistor (0402) 1 470Ω ±5% resistors (0402) R43, R54, R56 3 R63 1 560Ω ±5% resistor (0402) R64 1 20kΩ ±5% resistor (0402) R71 130kΩ ±5% resistor (0402) 1 R72 1 2.4kΩ ±5% resistor (0402) Baluns T2, T3 2 Toko 458DB-1616 450MHz quadrature transmitter U1 1 MAX2370EGM +2.8V LDO U2 1 MAX8867EUK28 Dual op amps U3, U4 2 MAX412ESA +3.0V LDOs U5, U8 2 MAX8867EUK30 V1 0 Open V2 0 Open VЗ 0 Open

IF Modulator Evaluation

- Connect the CDMA baseband signal generator to the I and Q ports using BNC connectors. Set the modulation to reverse-channel CDMA at an output level of 780mV_{P-P}. The nominal input level at the I/Q input pins is 130mV_{RMS}. Measure the differential voltage at the chip's I/Q inputs and adjust the signal generator's output if necessary to achieve 130mV_{RMS}.
- Connect IFOUT to the spectrum analyzer. Configure the spectrum analyzer to measure ACPR for reverse-channel CDMA. Set the center frequency to 120MHz with a -10dBm reference level and 30kHz resolution bandwidth.
- Adjust the V_{GC} voltage until the output power is -12dBm. The ACPR at ±885kHz offset will be approximately -66dBc, and the ACPR at ±1.98MHz will be approximately -84dBc.

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RF Upconverter Evaluation

- Connect a CDMA RF signal generator to the IFIN port using the SMA connector. Set the carrier frequency to 120MHz, set the output power to -16.5dBm, and set the modulation to reverse-channel CDMA.
- Connect RFL to the spectrum analyzer. Configure the spectrum analyzer to measure ACPR for reverse-channel CDMA. Set the center frequency to 455MHz with a +10dBm reference level and 30kHz resolution bandwidth.
- Set the V_{GC} voltage to 2.5V and adjust the IF input power until the RF output power is +8dBm. The ACPR at ±885kHz offset will be approximately -67dBc, and the ACPR at ±1.98MHz will be approximately -86dBc.

Cascaded Evaluation

- Connect the CDMA baseband signal generator to the I and Q ports using BNC connectors. Set the modulation to reverse-channel CDMA at a 780mVp-p output level. The nominal input level at the IC's I/Q input pins is 130mV_{RMS}. Measure the differential voltage at the chip's I/Q inputs and adjust the signal generator's output if necessary to achieve 130mV_{RMS}.
- 2) Connect an external 120MHz bandpass filter between the IFOUT and IFIN ports of the MAX2370 evaluation kit. A 50Ω filter with approximately 4dB of insertion loss is recommended, or an attenuator with a loss of 4dB can be used if a 120MHz filter is not available. The on-board baluns and matching networks at the IFOUT and IFIN ports each add approximately 0.5dB of loss, for a total IF loss of 5dB.
- Connect RFL to the spectrum analyzer. Configure the spectrum analyzer to measure ACPR for reverse-channel CDMA. Set the center frequency to 455MHz with a +10dBm reference level and 30kHz resolution bandwidth.
- Adjust the V_{GC} voltage until the RF output power is +8dBm. The ACPR at ±885kHz offset will be approximately -64dBc, and the ACPR at ±1.98MHz will be approximately -82dBc.

Adjustments and Control

VGA Adjust

Apply a voltage from 0.5V to 2.5V to header VGC to adjust the IF and RF VGA of the MAX2370. The VGC voltage is filtered on the EV kit to minimize undesired amplitude modulation.

Table 1. Register Settings

REGISTER NAME	TYPICAL REGISTER SETTINGS	REGISTER ADDRESS
RFM[17:0]	23000 _{DEC}	0000b
RFR[12:0]	384DEC	0001 _b
IFM[13:0]	4800 _{DEC}	0010 _b
IFR[10:0]	384DEC	0011 _b
OPCTRL[15:0]	090F _{HEX}	0100 _b
CONFIG[15:0]	D03F _{HEX}	0101 _b
I _{CC} CTRL[15:0]	0C38 _{HEX}	0110 _b
TEST[8:0]	100 _{HEX}	0111 _b

Interface Control

The interface port is designed to use a 20-pin ribbon cable (Figure 1); 10 pins are signal lines, and the other 10 pins are digital grounds. Pin 1 of the interface cable is red. Pin 1 is also designated in the silk screen on each of the PC boards.

Detailed Description

The following section covers the EV kit's circuit blocks in detail (refer to the MAX2370 data sheet for additional information).

I/Q Inputs

The single-ended I/Q signals are converted to differential by operational amplifiers on the EV kit. The op amps also provide DC bias to the I/Q input pins of the MAX2370. The EV kits are set up to provide 130mV_{RMS} differential to the IC when driven with an IS-95 forward-modulated source set to deliver 0.9V_{P-P} into a matched 50 Ω load.

Programming Interface

The programming interface is provided by the INTF2300 interface board. The interface board buffers and level shifts logic levels from the PC to the MAX2370 EV kit (refer to the INTF2300 documentation). These logic signals control the logic pins as well as the serial interface.

IFLO

The IFLO output port provides an output signal at the IF VCO frequency with a typical -12dBm output power. Enable the IFLO port by setting the BUF_EN bit in the OPCTRL register.

REF

REF is the reference frequency input to the RF and IF PLL. The REF port is AC-coupled. Make sure the reference signal has low phase noise, similar to that of a TCXO.



LOL

The MAX2370 EV kit requires an external RF local oscillator for evaluation. A low-noise RF signal generator can be connected to the EV kit's LOL port to act as the local oscillator. The minimum input level at the LOL port is -15dBm.

RFL

The MAX2370 evaluation kit is shipped with a matching network optimized for 400MHz to 500MHz. This matching network can be retuned to be optimized for evaluation at other RF frequencies.

IFIN± and IFOUT±

The MAX2370 evaluation kit is shipped configured for individual IF modulator and RF upconverter evaluation. IFIN± and IFOUT± are matched to 50Ω at 120MHz and on-board baluns at each port convert from differential to single-ended signals.

For cascaded evaluation, a 120MHz bandpass filter must be connected between the board's IFIN and IFOUT SMA connectors. A 50 Ω filter with a typical 4dB insertion loss is recommended to achieve the cascaded specifications quoted in the MAX2370 data sheet.

VBAT/VREG

V_{BAT} is the supply voltage to the PA driver circuitry. V_{REG} is the supply voltage to all MAX2370's circuits other than the PA driver. The VREG header must be connected to VBAT or connected to a separate 3V supply for proper operation.

Jumpers are provided to enable current measurement to each functional block of the IC (Table 2).

RBIAS

Resistor R74 (nominally $10k\Omega$) connects from RBIAS to ground and sets the bias current for the upconverters and PA driver stages. Output linearity or efficiency may be improved by adjusting the PA driver current through the I-MULT bits in the I_{CC} control register.

Table 2. Jumpers

JUMPER NUMBER	ASSOCIATED FUNCTIONAL BLOCK
JU1	V _{CC} for VCCDRIVER
JU2	Not used
JU3	Not used
JU4	VGC jumper
JU6	V _{CC} for PA predrivers
JU7	V _{CC} for RF mixer
JU8	V _{CC} for IF modulator
JU9	V _{CC} for digital interface
JU10	V _{CC} for RF charge pump
•	•

Layout Considerations

The MAX2370 EV kit can serve as a guide for your board layout. Keep PC board trace lengths as short as possible to minimize parasitics. Place decoupling capacitors as close to the IC as possible with a direct connection to the PC board's ground plane. Do not share decoupling capacitor ground vias with other ground connections.

PC Board Construction

The MAX2370 EV kit PC board uses a 14-mil-wide trace for 50Ω transmission line. The PC board has an 8-millayer profile on FR4 with a dielectric constant of 4.5.

INTF2300 SPI Interface Board

The INTF2300 interface board is used to interface 3-wire SPI protocol from a PC's parallel port to the EV kit. This board will level translate 5V logic from the PC to V_{CC} of the EV kit (this will typically be 3V logic). The INTF2300 also provides buffering and EMI filtering. Its absolute maximum supply voltage is 4.6V, limited by the breakdown of the buffer IC. The recommended operating supply voltage range is +2.7V to +3.6V.

Component Suppliers

SUPPLIER	PHONE	WEBSITE
Alpha Industries	617-935-5150	www.alphaindustries.com
AVX	803-946-0690	www.avxcorp.com
Coilcraft	847-639-6400	www.coilcraft.com
Johnson	507-833-8822	www.johnsoncomponents.com
Murata	770-436-1300	www.murata.com
Toko	708-297-0070	www.tokoam.com

Note: Indicate that you are using the MAX2370 when contacting these suppliers.



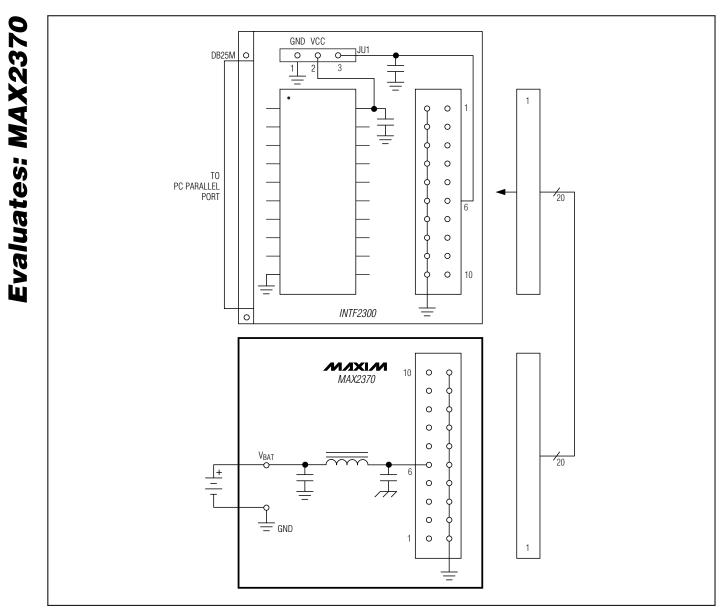


Figure 1. INTF2300 with MAX2370 EV Kit Providing Filtered Supply

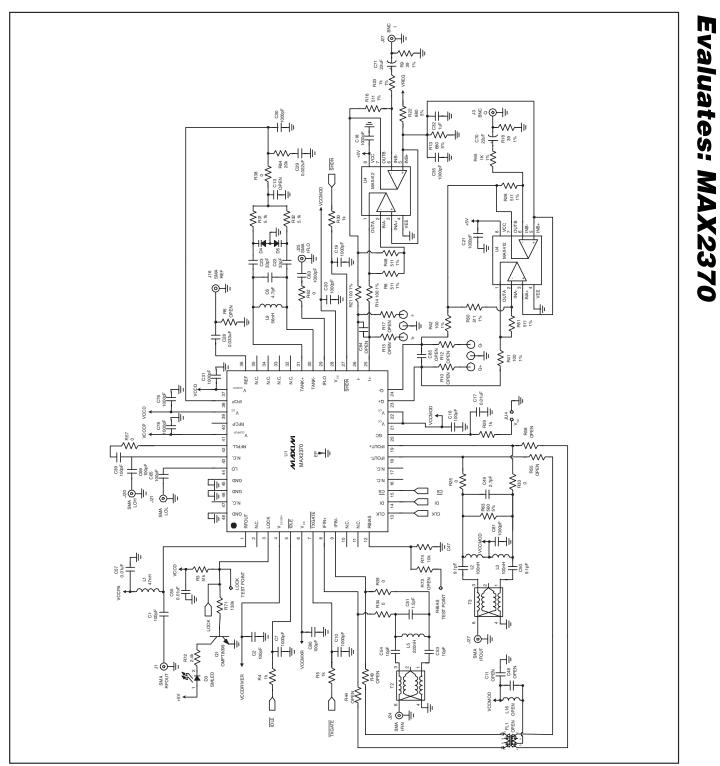


Figure 2. MAX2370 EV Kit Schematic (Sheet 1 of 2). Note: This schematic only represents components that are placed.

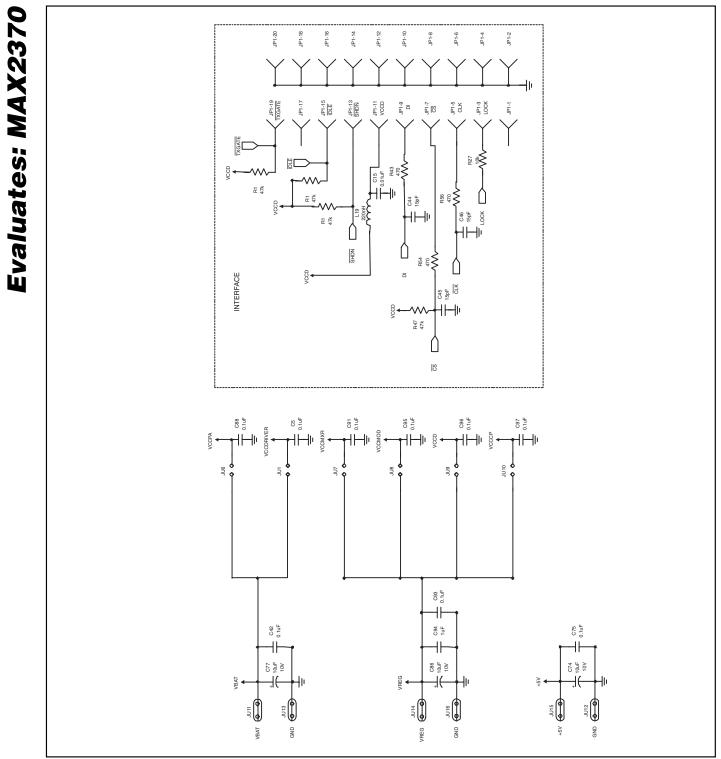


Figure 2. MAX2370 EV Kit Schematic (Sheet 2 of 2)

ANKH BYP LOH L L L L B LOL 88 R0 С R61 LOCK RÊL D3 LOCK TESTPOINT S S S C57 [1] C60 [14] <u>Minini (</u> 66 R3 6 CH 116 **IFLO** RZO 02 060 U1 J25R#14 52 **RFHO** 660 OG66R449 8 R62 C63 FL2 RF8 E VGC JU4 052 EE EE L16 0111048 GND 1771 FL1 RBIAS IF ÎN WW.MAXIM-IC.COM 1-408-737-7600 MAX2361/63W AND 2370 \bigcirc ËV KIT J7 a vccdriver VCO # PCS_VCO S VCCMOD **a VCCMXR** NCCCP S ACCD IFOUT CELL B J3 C#9 C68 Ü Ü Ő Ő /CCPA **U10** JU6 5 107 JU8 00 JU3 JU2 Q C#2 C75 093 JP1 C86 C77 C74 Q+ GND Q-GND |-1+ 0 JU11 JU16 JU13 JU12 JU14 U15 VREG VBAT GND +51 GND GNE

MAX2370 Evaluation Kit

Figure 3. MAX2370 EV Kit Component Placement Guide—Component Side (Top View)

Evaluates: MAX2370

Evaluates: MAX2370

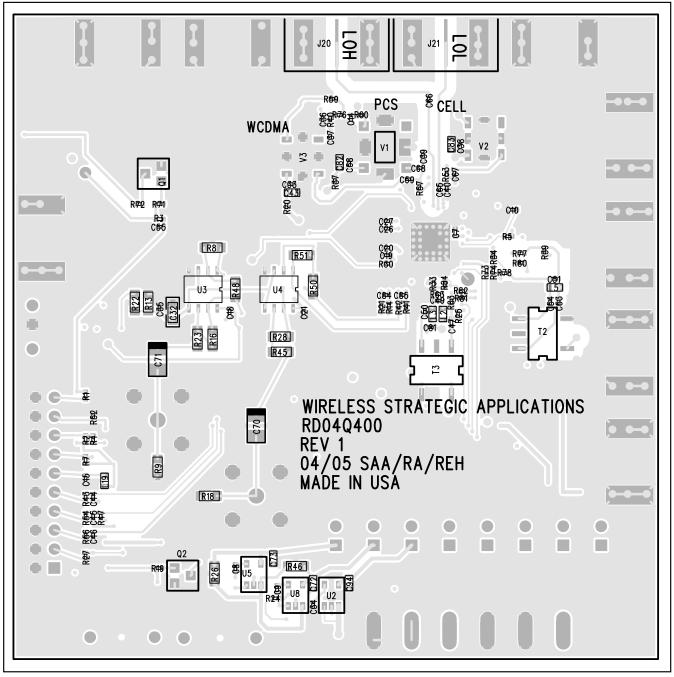


Figure 4. MAX2370 EV Kit Component Placement Guide—Solder Side (Bottom View)

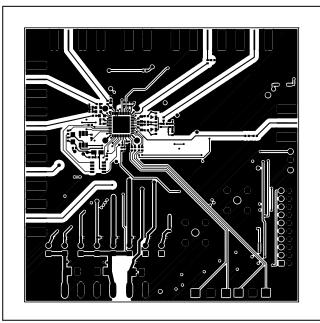


Figure 5. MAX2370 EV Kit PC Board Layout—Component Side (Top View)

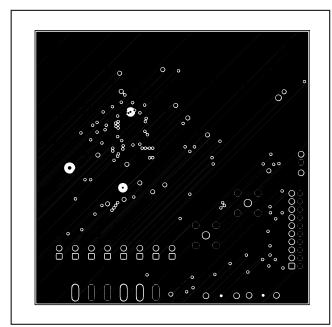


Figure 6. MAX2370 EV Kit PC Board Layout—Inner Layer 2 (Ground Plane, Top View)

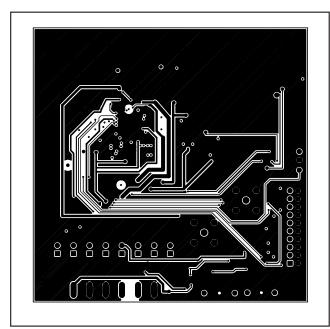


Figure 7. MAX2370 EV Kit PC Board Layout—Inner Layer 3 (Top View)

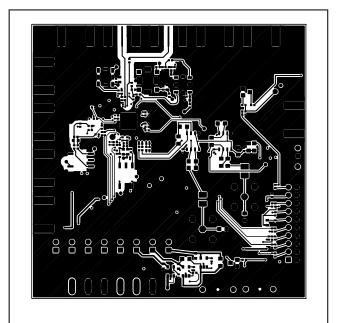


Figure 8. MAX2370 EV Kit PC Board Layout—Solder Side (Bottom View)

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